Product data sheet

1. General description

Planar passivated four quadrant triac in a SOT78 (TO-220AB) plastic package intended for use in general purpose bidirectional switching and phase control applications.

2. Features and benefits

- · High blocking voltage capability
- Least sensitive gate for highest noise immunity
- High minimum I_{GT} for guaranteed immunity to gate noise
- · Planar passivated for voltage ruggedness and reliability
- Triggering in all four quadrants

3. Applications

- General purpose motor controls
- Lighting controls
- Applications where only positive gate drive is avaliable
- · Applications where gate noise or interference may occur

4. Quick reference data

Table 1. Quick reference data

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|---------------------|--|--|-----|-----|-----|------|
| V_{DRM} | repetitive peak off-state voltage | | - | - | 500 | V |
| $I_{T(RMS)}$ | RMS on-state current | full sine wave; $T_{mb} \le 102 ^{\circ}\text{C}$; Fig. 1; Fig. 2; Fig. 3 | - | - | 8 | А |
| T_j | junction temperature | | - | - | 125 | °C |
| I _{TSM} | non-repetitive peak on- state current | full sine wave; $T_{j(init)} = 25 ^{\circ}C$; $t_p = 20 \text{ms}$; Fig. 4; Fig. 5 | - | - | 65 | А |
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
| Static ch | aracteristics | | | | | |
| I _{GT} | gate trigger current | $V_D = 12 \text{ V; } I_T = 0.1 \text{ A; } T2+ \text{ G+;}$ $T_j = 25 \text{ °C; } Fig. 7$ | 10 | - | 50 | mA |
| | | $V_D = 12 \text{ V; } I_T = 0.1 \text{ A; } T2 + G-;$ $T_j = 25 \text{ °C; } Fig. 7$ | 10 | - | 50 | mA |
| | | $V_D = 12 \text{ V; } I_T = 0.1 \text{ A; T2- G-;}$ $T_j = 25 \text{ °C; } Fig. 7$ | 10 | - | 50 | mA |
| | | $V_D = 12 \text{ V; } I_T = 0.1 \text{ A; T2- G-;}$ $T_j = 25 \text{ °C; } Fig. 7$ | 10 | - | 100 | mA |
| Dynamic | characteristics | | | | | |
| dV _D /dt | rate of rise of off-state voltage | V_{DM} = 402 V; T_j = 125 °C; (V_{DM} = 67% of V_{DRM}); exponential waveform; gate open circuit | 200 | - | - | V/µs |

5. Pinning information

Table 2. Pinning information

| Symbol | Description | Simplified outline | Graphic symbol |
|--------|--------------------------------|--|---|
| T1 | main terminal 1 | mb | |
| T2 | main terminal 2 | 705 | T2 |
| G | gate | | Sym051 |
| T2 | mounting base; main terminal 2 | | symos i |
| | | | |
| | | | |
| | | | |
| | T1 T2 G | T1 main terminal 1 T2 main terminal 2 G gate | T1 main terminal 1 T2 main terminal 2 G gate T2 mounting base; main terminal 2 |

6. Ordering information

Table 3. Ordering information

| Type number | Package | | | | | | | |
|--------------|----------|---|---------|--|--|--|--|--|
| | Name | Description | Version | | | | | |
| BTA137-600G0 | TO-220AB | plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB | SOT78 | | | | | |

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|---------------------|--------------------------------------|---|-----|-----|------------------|
| V_{DRM} | repetitive peak off-state voltage | | - | 600 | V |
| I _{T(RMS)} | RMS on-state current | full sine wave; T _{mb} ≤ 102 °C; Fig. 1; Fig. 2; Fig. 3 | - | 8 | А |
| I _{TSM} | non-repetitive peak on-state current | full sine wave; $T_{j(init)} = 25 \text{ °C}$; $t_p = 20 \text{ ms}$; Fig 4; Fig 5 | - | 65 | А |
| | | full sine wave; $T_{j(init)}$ = 25 °C; t_p = 16.7 ms | - | 71 | Α |
| l²t | I ² t for fusing | t _p = 10 ms; sine-wave pulse | - | 21 | A ² s |
| dl _⊤ /dt | rate of rise of on-state current | I _G = 0.1 A; T2+ G+ | - | 50 | A/µs |
| | | I _G = 0.1 A; T2+ G- | - | 50 | A/µs |
| | | I _G = 0.1 A; T2- G- | - | 50 | A/µs |
| | | I _G = 0.2 A; T2- G+ | - | 10 | A/µs |
| I _{GM} | peak gate current | | - | 2 | Α |
| P_GM | peak gate power | | - | 5 | W |
| $P_{G(AV)}$ | average gate power | over any 20 ms period | - | 0.5 | W |
| T _{stg} | storage temperature | | -40 | 150 | °C |
| T _j | junction temperature | | - | 125 | °C |

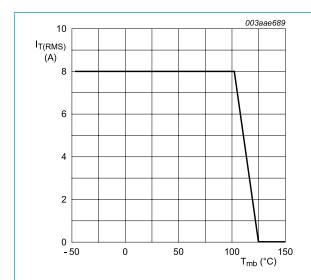
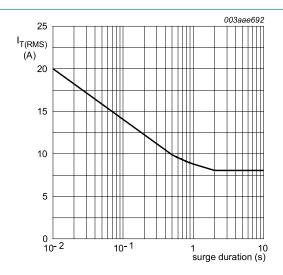
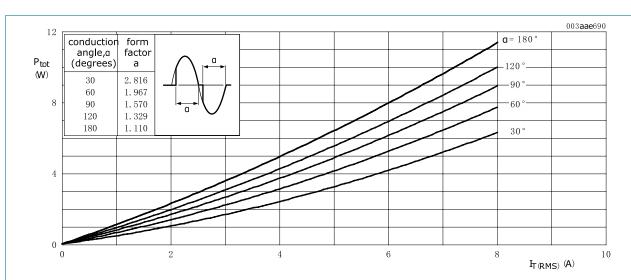


Fig. 1. RMS on-state current as a function of mounting base temperature; maximum values



f = 50 Hz; $T_{mb} \le 102 \, ^{\circ}C$

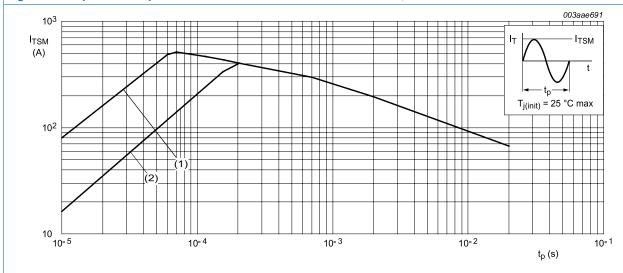
Fig. 2. RMS on-state current as a function of surge duration; maximum values



 α = conduction angle

 $a = form factor = I_{T(RMS)} / I_{T(AV)}$

Fig. 3. Total power dissipation as a function of RMS on-state current; maximum values



t_p ≤ 20 ms

(1) dl_⊤/dt limit

(2) T2- G+ quadrant limit

Fig. 4. Non-repetitive peak on-state current as a function of pulse width; maximum values

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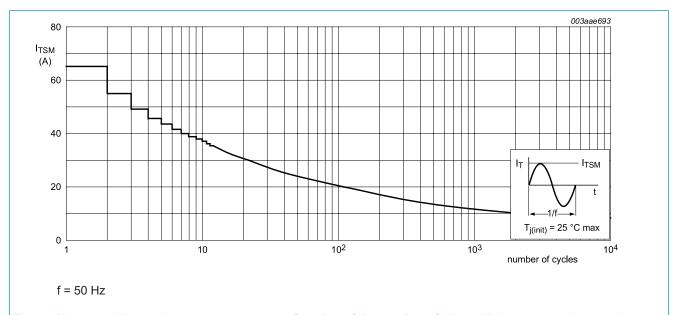


Fig. 5. Non-repetitive peak on-state current as a function of the number of sinusoidal current cycles; maximum values

8. Thermal characteristics

Table 5. Thermal characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|--|---|---------------------------|-----|-----|-----|------|
| R _{th(j-mb)} thermal resistance | | full cycle; Fig. 6 | - | - | 2 | K/W |
| | from junction to mounting base | half cycle; <u>Fig. 6</u> | - | - | 2.4 | K/W |
| R _{th(j-a)} | thermal resistance from junction to ambient | in free air | - | 60 | - | K/W |

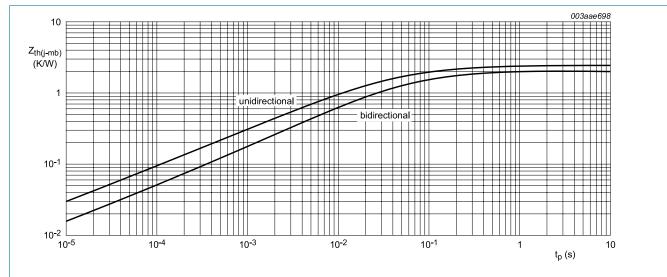


Fig. 6. Transient thermal impedance from junction to mounting base as a function of pulse width

9. Characteristics

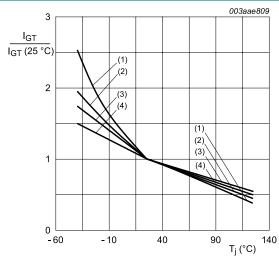
Table 6. Characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------------------|---------------------------------------|--|------|-----|------|------|
| Static ch | aracteristics | | ' | | | |
| I _{GT} | gate trigger current | $V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T2+ G+;$ $T_j = 25 \text{ °C}; Fig. 7$ | 10 | - | 50 | mA |
| | | $V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T2+ \text{ G-};$ $T_j = 25 \text{ °C}; Fig. 7$ | 10 | - | 50 | mA |
| | | $V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T2- \text{ G-};$ $T_j = 25 \text{ °C}; Fig. 7$ | 10 | - | 50 | mA |
| | | $V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T2- G+; $ $T_j = 25 \text{ °C}; Fig. 7$ | 10 | - | 100 | mA |
| I _L | latching current | $V_D = 12 \text{ V}; I_G = 0.1 \text{ A}; T2+ G+;$ $T_j = 25 \text{ °C}; Fig. 8$ | - | - | 45 | mA |
| | | $V_D = 12 \text{ V}; I_G = 0.1 \text{ A}; T2+ \text{ G-};$ $T_j = 25 \text{ °C}; Fig. 8$ | - | - | 60 | mA |
| | | $V_D = 12 \text{ V}; I_G = 0.1 \text{ A}; \text{ T2- G-};$ $T_j = 25 \text{ °C}; \frac{\text{Fig. 8}}{\text{Fig. 8}}$ | - | - | 45 | mA |
| | | $V_D = 12 \text{ V}; I_G = 0.1 \text{ A}; \text{ T2- G+};$ $T_j = 25 \text{ °C}; \underline{\text{Fig. 8}}$ | - | - | 60 | mA |
| I _H | holding current | V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u> | - | - | 40 | mA |
| V _T | on-state voltage | I _T = 10 A; T _j = 25 °C; <u>Fig. 10</u> | - | 1.3 | 1.65 | V |
| V_{GT} | gate trigger voltage | V _D = 12 V; I _T = 0.1 A;T _j = 25 °C; <u>Fig. 11</u> | - | 0.7 | 1 | V |
| | | $V_D = 400V; I_T = 0.1 A; T_j = 25 °C; Fig. 11$ | 0.25 | 0.4 | - | V |
| I _D | off-state current | V _D = 600 V; T _j = 125 °C | - | 0.1 | 0.5 | mA |
| Dynamic | characteristics | | I | | | |
| dV _D /dt | rate of rise of off-state voltage | $V_{\rm DM}$ = 402 V; $T_{\rm j}$ = 125 °C; ($V_{\rm DM}$ = 67% of $V_{\rm DRM}$); exponential waveform; gate open circuit | 200 | - | - | V/µs |
| dV _{com} /dt | rate of change of commutating voltage | V_D = 400 V; Tj = 95 °C; dI_{com}/dt = 3.6 A/ ms; IT = 8 A; gate open circuit | 10 | - | - | V/µs |
| t _{gt} | gate-controlled turn-on time | $I_{TM} = 12 \text{ A}; V_D = 600 \text{ V}; I_G = 0.1 \text{ A};$ $dI_G/dt = 5 \text{ A}/\mu\text{s}$ | - | 2 | - | μs |

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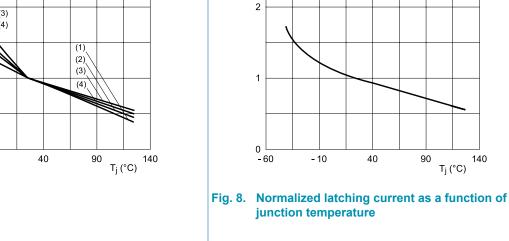
T_j (°C)

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- (1) T2- G+
- (2) T2- G-
- (3) T2+ G-
- (4) T2+ G+

Fig. 7. Normalized gate trigger current as a function of junction temperature



3

ΙL I_{L(25°C)}

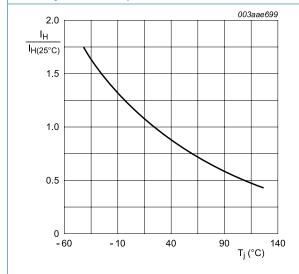
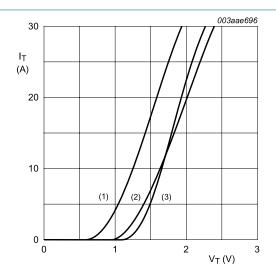


Fig. 9. Normalized holding current as a function of junction temperature



 $V_0 = 1.264 \text{ V}$; Rs = 0.038 Ω

(1) $T_j = 125 \, ^{\circ}C$; typical values

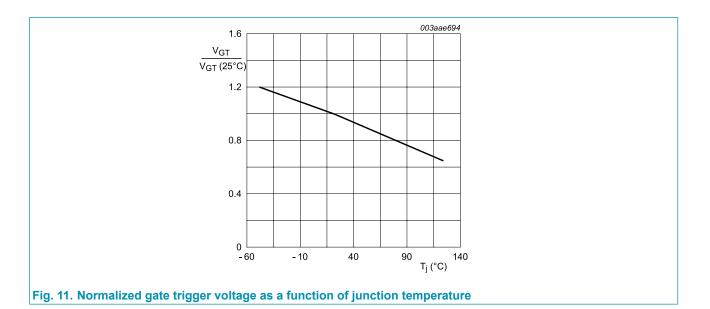
(2) T_i = 125 °C; maximum values

(3) $T_i = 25$ °C; maximum values

Fig. 10. On-state current as a function of on-state voltage

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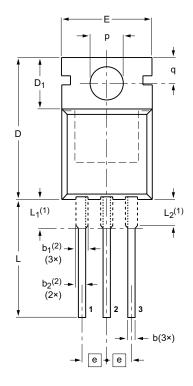
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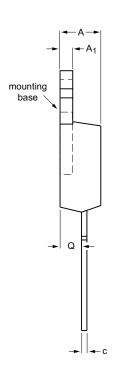


10. Package outline

Plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB

SOT78





0 5 10 mm

DIMENSIONS (mm are the original dimensions)

| UNIT | Α | A ₁ | b | b ₁ ⁽²⁾ | b ₂ ⁽²⁾ | С | D | D ₁ | E | е | L | L ₁ ⁽¹⁾ | L ₂ ⁽¹⁾ max. | р | q | Q |
|------|------------|----------------|------------|-------------------------------|-------------------------------|------------|--------------|----------------|-------------|------|--------------|-------------------------------|---------------------------------------|------------|------------|------------|
| mm | 4.7 4.1 | 1.40 1.25 | 0.9 0.6 | 1.6 1.0 | 1.3 1.0 | 0.7 0.4 | 16.0 15.2 | 6.6 5.9 | 10.3 9.7 | 2.54 | 15.0 12.8 | 3.30 2.79 | 3.0 | 3.8 3.5 | 3.0 2.7 | 2.6 2.2 |

Notes

- 1. Lead shoulder designs may vary.
- 2. Dimension includes excess dambar.

| OUTLINE | | REFER | EUROPEAN | ISSUE DATE | | |
|---------|-----|-----------------|----------|------------|------------|---------------------------------|
| VERSION | IEC | JEDEC | JEITA | | PROJECTION | ISSUE DATE |
| SOT78 | | 3-lead TO-220AB | SC-46 | | | 08-04-23 08-06-13 |

40 Triad

11. Legal information

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| Document status [1][2] | Product status [3] | Definition |
|--------------------------------------|--------------------|---|
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